



Alpha Particle or Neutron SER - What Will Dominate in Future IC Technology?

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Outline

- Source of alpha soft errors
- Source of neutron soft errors
- Device scaling trends
- Deposited energy of alpha particles and neutrons
- Critical energy vs design rule
- Trend of alpha and neutron soft errors
- Conclusions

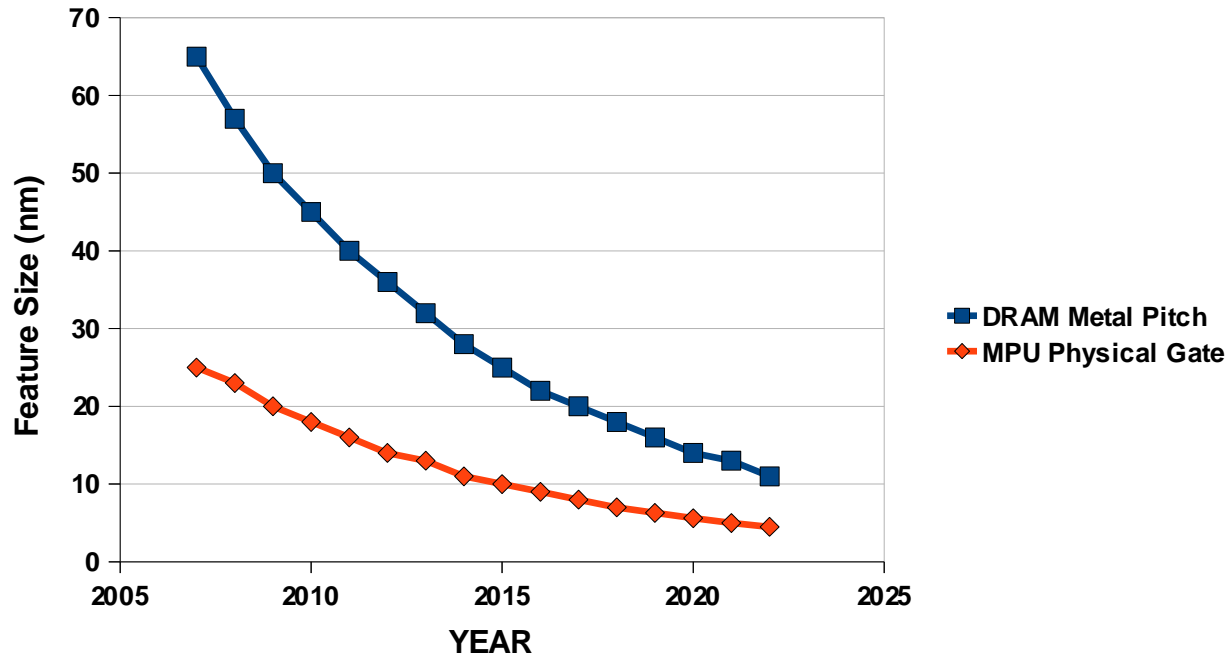
Source of Alpha SER

- Process Contamination in Wafer Fab Materials
 - > happens rarely but can be catastrophic if not detected early enough
- Trace elements in plastic packaging
 - > reduced with higher purity materials (cost \$\$)
 - > reduced with low-alpha die coating materials
- Trace elements in lead bumps
 - > reduced with isotopically purified Pb (cost \$\$)
 - > Reduced with “keep out” areas around bumps and low alpha underfill

Source of Neutron SER

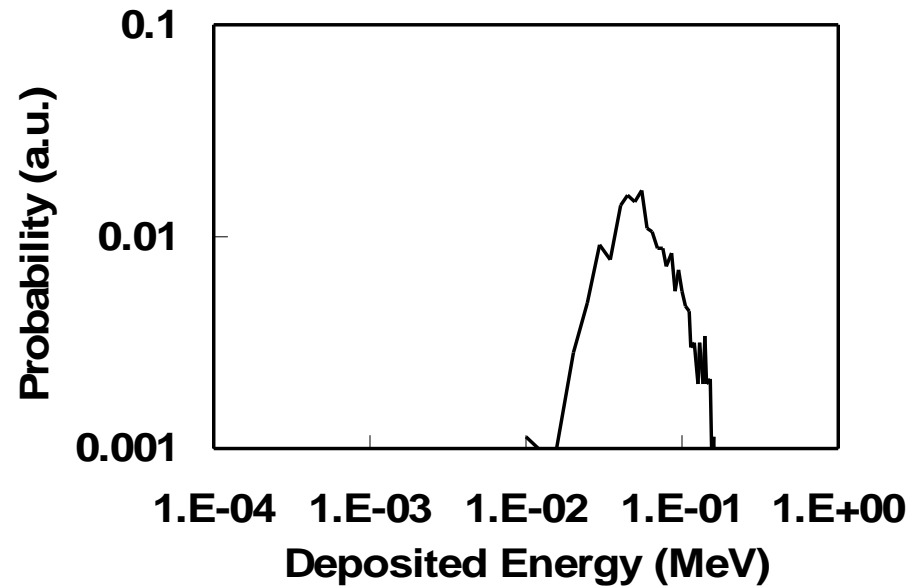
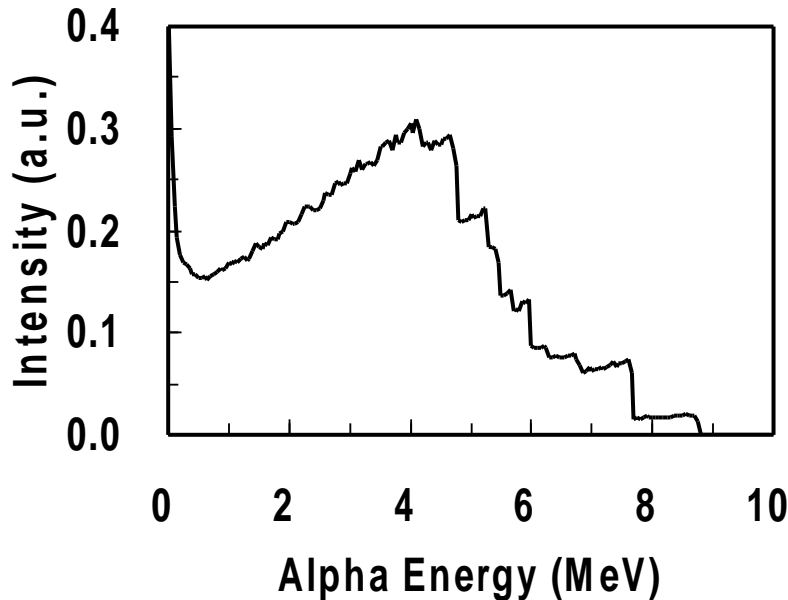
- High Energy Neutrons (100KeV - 1GeV) from cosmic ray background
 - > not practical to shield
 - > deep penetration (~10ft concrete)
 - > live with it!
- Low Energy Neutrons (10meV to 1eV) from thermalization of high energy neutrons
 - > background thermal neutron flux depends on high energy flux and building environment (some materials “absorb” thermal neutrons)
 - > large scatter cross section with ^{10}B
 - > easy to shield with ^{10}B containing materials
 - > not believed to be a problem for non-BPSG processes (???)
 - > insufficient quantitative data to indicate if boron doping causes a problem

ITRS Roadmap



Source: ITRS 2007 Executive Summary (<http://www.itrs.net/Links/2007ITRS/Home2007.htm>)

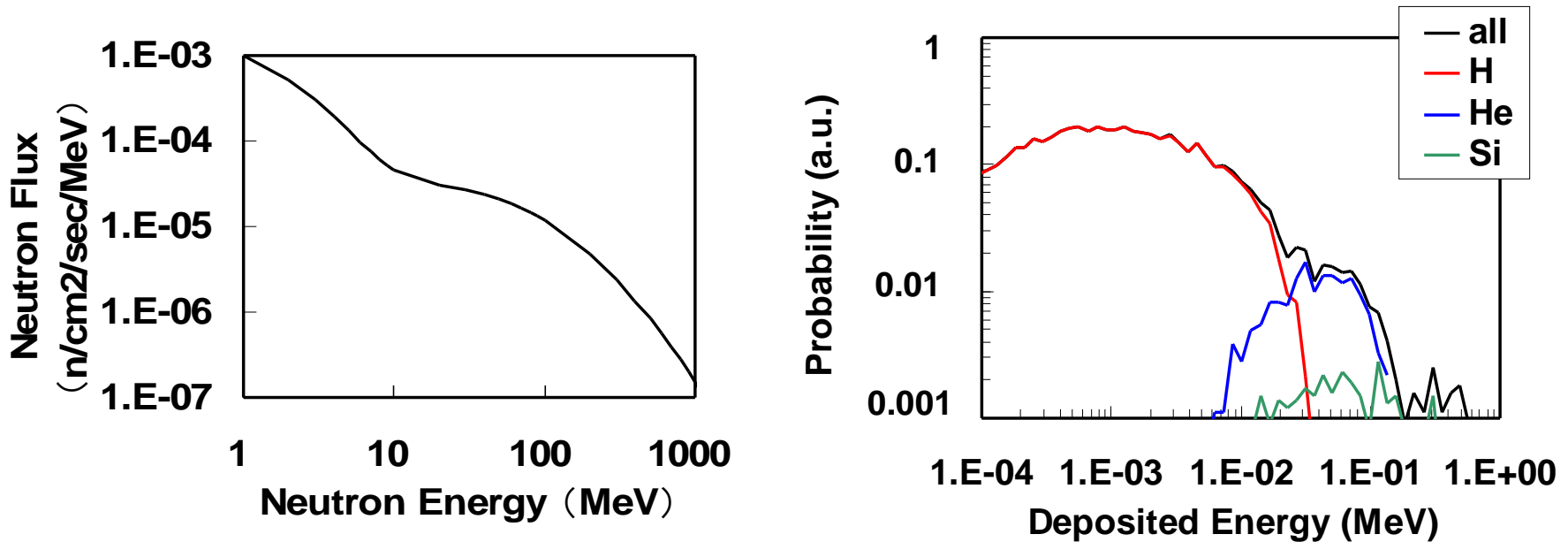
Alpha Particle Energy Deposition



$$SER(Q_c) \propto \int_{Q_c}^{\infty} P(q) dq$$

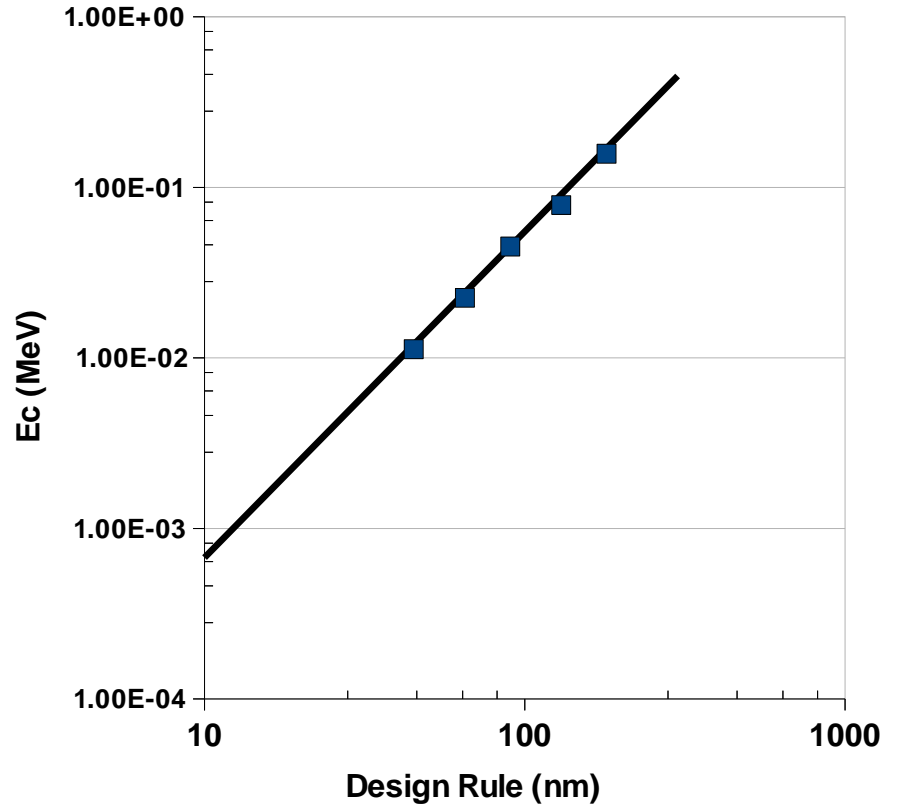
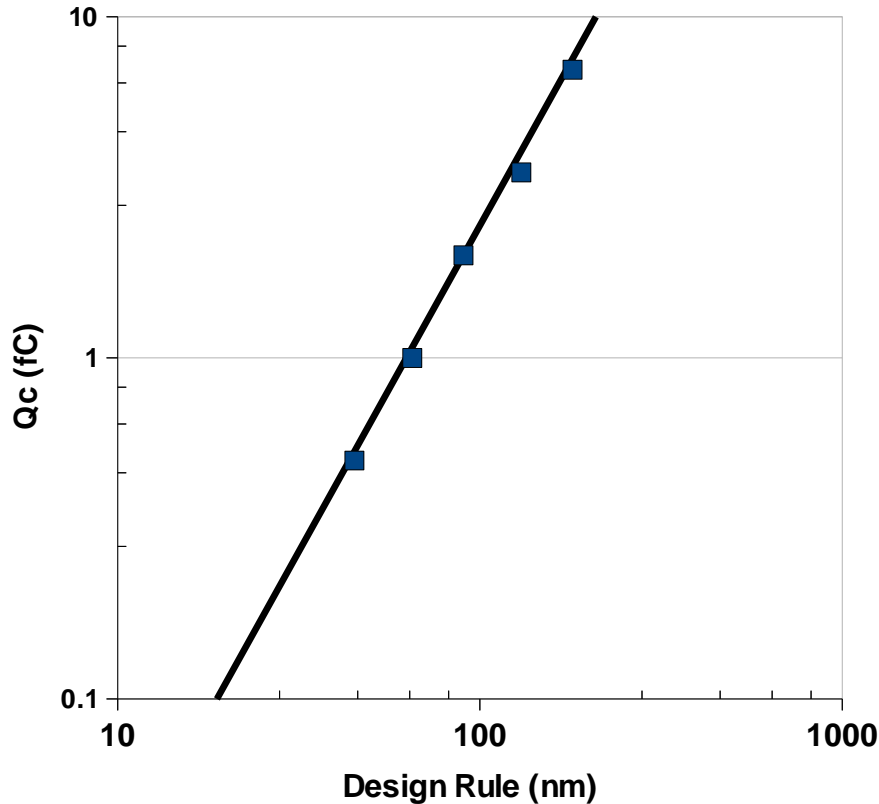
- Translate deposited energy to deposited charge (3.6eV/e-h pair)
- Critical Energy E_c (MeV) = $2.25 \cdot 10^{-2} Q_c$ (fC)

Neutron Energy Deposition



- Neutron energy deposition much broader and extends to lower energies compared to alpha particles
- Low energy contribution due to proton generation from nuclear collisions

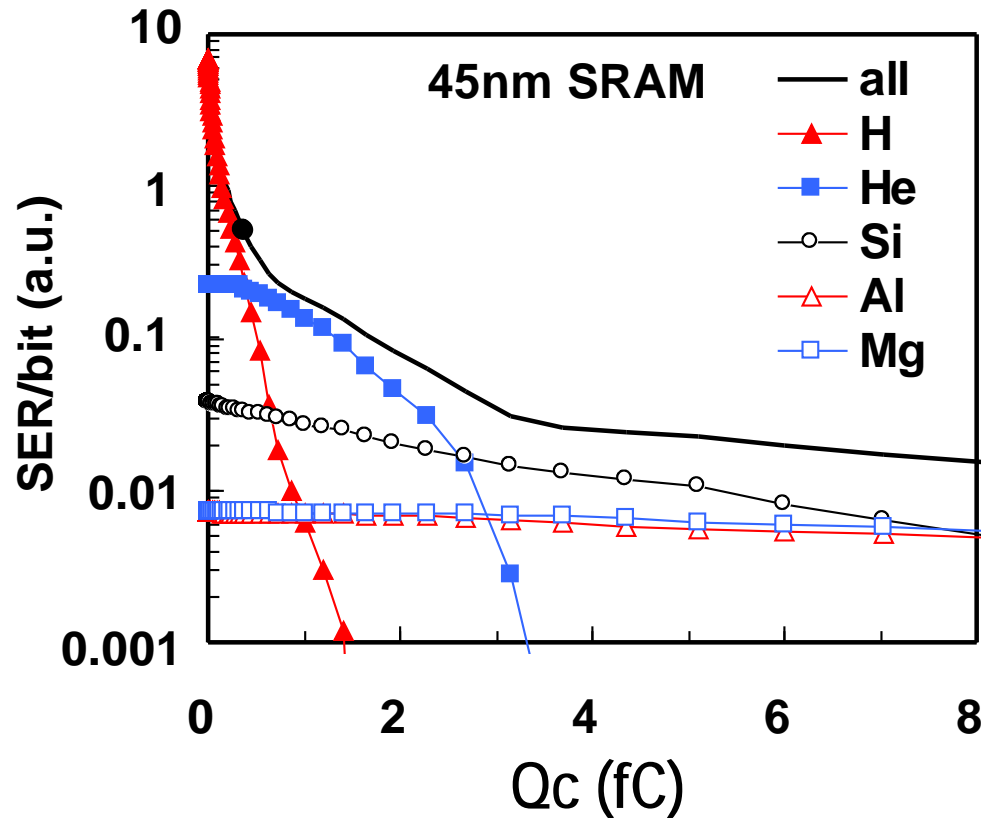
Critical Energy vs Design Rule



- Below 45nm, critical energy for upset is moving into proton distribution!
- Alpha SER will stay flat but neutron SER will increase

Source: H. Kobayashi et al, "Alpha Particle and Neutron-induced Soft Error Rates and Scaling Trends in SRAM", Proc. IEEE 47th Annual International Reliability Physics Symposium, Montreal, 2009, pp 206-211.

n + Si Product Particles Contributing to Neutron Soft Errors



- The sharp rise below 0.6fC (13.5keV) is due to the direct ionization of protons

Conclusions

- Alpha particle
 - Trade-off of \$ (high purity materials and circuit design) vs acceptable $SERa$
 - Remain roughly flat below 45nm
- Neutron
 - Trade-off of \$ (circuit design) vs acceptable SER_n
 - Could continue to trend upward below 45nm without techniques to address proton generation



Thank You!

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